Unleash your true potential.
MY700™ Jet Printer options and upgrades.

Trouble-free solder paste application. As an experienced Jet Printer user, you know that the MY700 platform is a cornerstone in high mix production, enabling high yield and maximum flexibility. But are you aware of the many options we have for the MY700 that are retrofittable in the field?

INCREASE YIELD WITH 2D INSPECT & REPAIR
Enable 2D inspect & repair software option to check print quality and fix coverage issues before the PCB goes to the pick-and-place machine.

INCREASE YOUR THROUGHPUT
Add the high speed software option to increase the speed of your Jet Printer and become more productive instantly.

INCREASE PRODUCTIVITY WITH THE WIPE STATION
Add a wipe station to automate the process of cleaning the underside of ejectors. This will increase productivity by reducing the number of stoppages and operator interventions.

EXPAND YOUR FINE PITCH CAPABILITY
The MY700 can be upgraded with fine pitch software and cleaning pressure station, enabling 01005 chip size printing.

JET DISPENSING WITH 3RD PARTY JET VALVES
Upgrade your MY700JP to a MY700JX Jet Dispenser, opening up the possibility to jet a large range of different fluids such as adhesive and underfill.

HANDLE LONGER BOARDS
With the board indexing SW option activated, the MY700 can handle up to 510 mm x 580 mm large boards.

PART NUMBER	DESCRIPTION
4007545 29704	2D Inspect & Repair SW
4007545 29701	High Speed SW Including On The Fly
4048106	Cleaning Wipe Station
4007545 29702	Fine Pitch SW
4008683	Cleaning Pressure Station
4007545 29714	Board Indexing SW

3rd party valves are dependent on application